

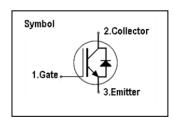
IGBT

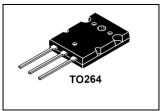
Features

- 1200V,50A
- V_{CE(sat)(typ.)}=2.1V@V_{GE}=15V,I_C=50A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA using NPT technology



JIAEN NPT IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating),UPS, general inverter and other soft switching applications.





Absolute Maximum Ratings

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	1200	V
V _{GES}	Gate-Emitter Voltage	<u>+</u> 30	V
I.	Continuous Collector Current (Tc=25 °C)	100	А
IC	Continuous Collector Current (Tc=100°C)		А
Ісм	Pulsed Collector Current (Note 1)	150	А
l _F	Diode Continuous Forward Current (Tc=100 °C)	50	А
I _{FM}	Diode Maximum Forward Current (Note 1)	150	А
t _{sc}	Short Circuit Withstand Time (Tj≤150℃)	10	us
D-	Maximum Power Dissipation (Tc=25 ℃)	520	W
P _D	Maximum Power Dissipation (Tc=100°C)	208	W
TJ	Operating Junction Temperature Range	-55~150	℃
T _{STG}	Storage Temperature Range	-55~150	°C

Thermal Characteristics

Symbol	Parameter	Max.	Units
R _{th j-c}	Thermal Resistance, Junction to case for IGBT	0.24	°C/ W
R _{th j-c}	R _{th j-c} Thermal Resistance, Junction to case for Diode		°C/ W
R _{th j-a}	Thermal Resistance, Junction to Ambient	25	°C/ W



Electrical Characteristics (Tc=25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units		
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA		1200	-	-	V		
I _{CES}	Collector-Emitter Leakage Current	V _{CE} = 120	0V, V _{GE} = 0V	-	-	250	uA		
ı	Gate Leakage Current, Forward	V _{GE} =30V	, V _{CE} = 0V	-	-	100	nA		
I _{GES}	Gate Leakage Current, Reverse	V _{GE} = -30	V, V _{CE} = 0V	-	-	-100	nA		
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, I _C = 250uA	4.5	-	6.0	V		
		\/ 45\/	Tc=25℃		2.1	2.6	V		
$V_{CE(sat)}$		$V_{GE} = 15V$ $I_{C} = 50A$	Tc=125°C		2.6		V		
		10- 00/ t	Tc=150°C		2.7		V		
Qg	Total Gate Charge	Vcc=960	/	-	340		nC		
Qge	Gate-Emitter Charge Gate-Collector Charge		V _{GE} =15V		102		nC		
Qgc	Gate-Collector Charge	I _C =50A		-	170		nC		
t d(on)	Turn-on Delay Time			-	49	-	ns		
t r	Turn-on Rise Time	Vcc=600	/	-	95	-	ns		
t d(off)	Turn-off Delay Time	Vcc=600V V _{GE} =15V Ic=50A Ro=150		V _{GE} =15V		-	630	-	ns
t f	Turn-off Fall Time			-	55	-	ns		
Eon	Turn-on Switching Loss	-	R _G =15Ω Inductive Load		3.42	-	mJ		
Eoff	Turn-off Switching Loss	I _C =50A R _G =15Ω		-	3.16	-	mJ		
Ets	Total Switching Loss]		-	6.58	-	mJ		
C _{ies}	Input Capacitance	V _{CE} =25\/		-	2834	-	pF		
Coes	Output Capacitance	V _{CE} =25V V _{GE} =0V		-	360	-	pF		
C _{res}	Reverse Transfer Capacitance	f = 1MHz	_	1	218	-	pF		

Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _F	Diode Forward Voltage	I _F =50A	-	1.84	3.5	V
trr	Diode Reverse Recovery Time	V _{CE} = 600V	-	292	-	ns
Irr	Diode peak Reverse Recovery Current	I _F = 50A	•	23.7		Α
Qrr	Diode Reverse Recovery Charge	dlF/dt = 200A/us	-	2878		nC

Notes.

1. Repetitive Rating: Pulse width limited by maximum junction temperature



Typical Performance Characteristics

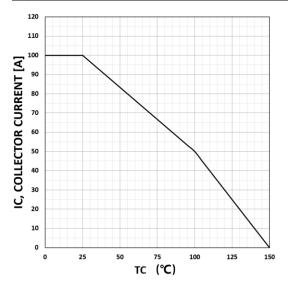


Figure 1. Maximum DC collector current VS. case temperature

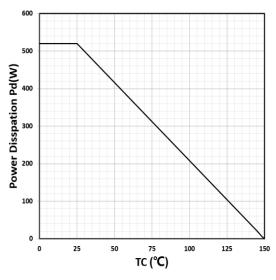


Figure 2. Power dissipation VS. case temperature

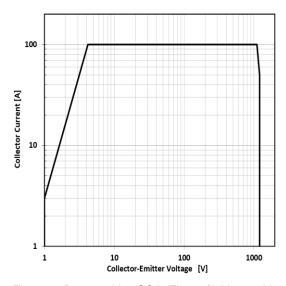


Figure 3. Reverse bias SOA, Tj=125 $^{\circ}$ C,Vge=15V

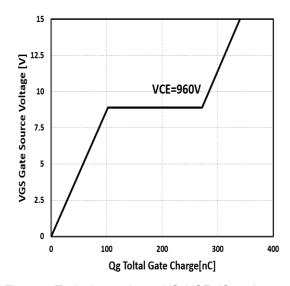


Figure 4. Typical gate charge VS. VGE, IC=50A



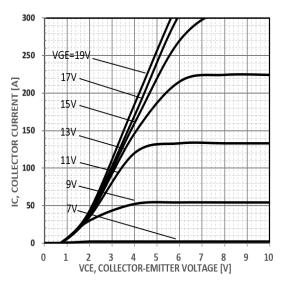


Figure 5. Typical output characteristics $tp{=}300us \;\; Tc{=}25\,{}^{\circ}\!\mathbb{C}$

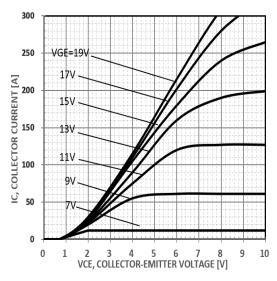


Figure 6. Typical output characteristics tp=300us Tc=150°C

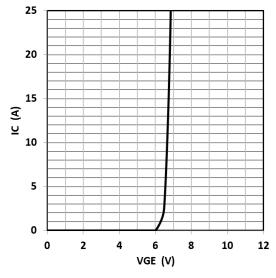


Figure 7. Typical gate threshold voltage

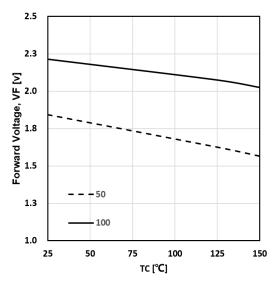


Figure 8. Typical forward voltage vs Tc



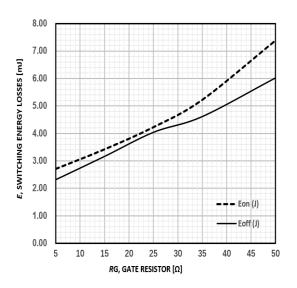


Figure 9. Typical energy loss VS. Rg,TC=25°C, VCE=600V, VGE=15V ,IC=50A

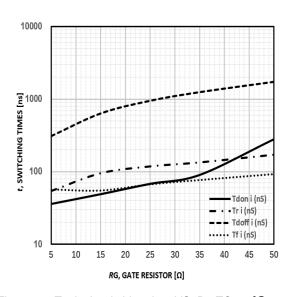


Figure 10. Typical switching time VS. Rg,TC=25°C, VCE=600V, VGE=15V ,IC=50A

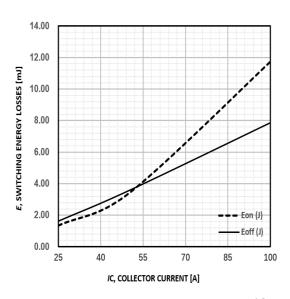


Figure 11. Typical energy loss VS. IC, TC=25°C, TC=25°C, VCE=600V, VGE=15V ,RG=15 Ω

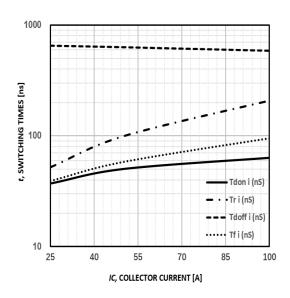


Figure 12. Typical switching time VS. IC, $VCE=600V,\,VGE=15V,RG=15\Omega$



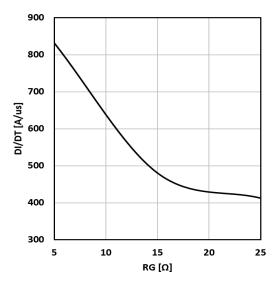


Figure 13. Typical diode di/dt vs rg $Tc=25^{\circ}C$ VCE=600V VGE=15V IF=50A

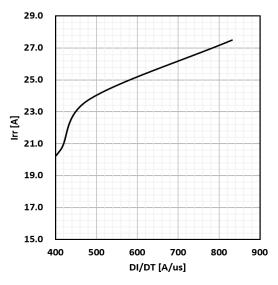


Figure 14. Typical diode irr vs di/dt Tc=25°C VCE=600V VGE=15V IF=50A

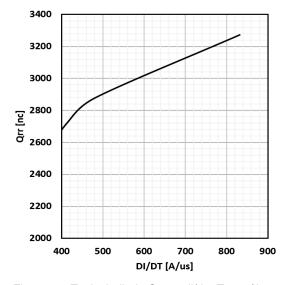


Figure 15. Typical diode Qrr vs di/dt $Tc=25^{\circ}C$ VCE=600V VGE=15V IF=50A

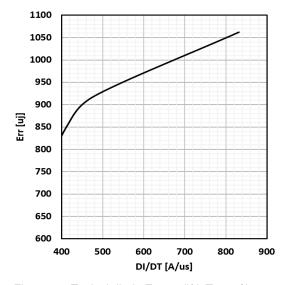


Figure 16. Typical diode Err vs di/dt Tc=25°C VCC=600V VGE=15V IF=50A



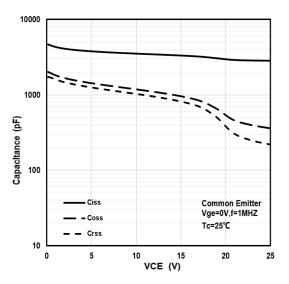


Figure17. Typical capacitance VS. VCE, VGE=0V,f=1MHz

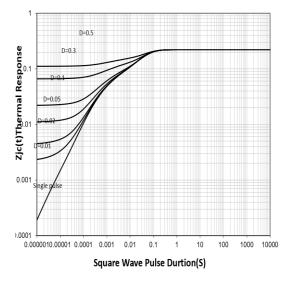
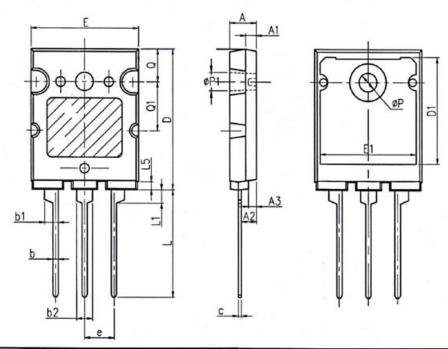


Figure 18. normalized transient thermal impedance, junction-to-case



TO264 PACKAGE OUTLINE



SYMBOL	rom		CAMBOL	ROTT			
	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX
A	4.80	5. 00	5 20	E	19. 50	20.00	20. 50
A1		2.00	REF	E1	16.00		
A2	2. 50	2. 80	3. 10	е	5. 45 TYP		
A3	1. 50 REF			L	19. 50 20. 00 20. 5		
b	0.90	1.00	1. 25	L1	2.30	2. 50	2.70
b1	2.30	2. 50	2.75	L5	1. 35 REF		
b2	2.80	3.00	3. 20	ΦР	3.00	3. 20	3. 40
С	0.50	0.60	0.85	ФР1	3. 20	3. 40	3.60
D	25. 70	26.00	26. 30	Q	5.80	6.00	6. 20
D1	19.00	-	=	Q1	8.80	9.00	9. 20



JNG50N120LS

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